

TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087I – DECEMBER 1994 – REVISED AUGUST 1997

- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- Precision Voltage Sensor
- Temperature-Compensated Voltage Reference
- Programmable Delay Time by External Capacitor
- Supply Voltage Range . . . 2 V to 6 V
- Defined RESET Output from $V_{DD} \geq 1$ V
- Power-Down Control Support for Static RAM With Battery Backup
- Maximum Supply Current of $16 \mu\text{A}$
- Power Saving Totem-Pole Outputs
- Temperature Range . . . -40°C to 125°C

description

The TLC77xx family of micropower supply voltage supervisors provide reset control, primarily in microcomputer and microprocessor systems.

During power-on, RESET is asserted when V_{DD} reaches 1 V. After minimum V_{DD} (≥ 2 V) is established, the circuit monitors SENSE voltage and keeps the reset outputs active as long as SENSE voltage ($V_{I(SENSE)}$) remains below the threshold voltage. An internal timer delays return of the output to the inactive state to ensure proper system reset. The delay time, t_d , is determined by an external capacitor:

$$t_d = 2.1 \times 10^4 \times C_T$$

where

C_T is in farads

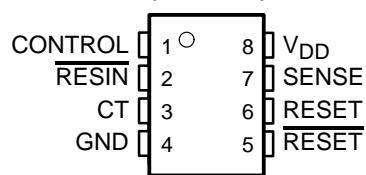
t_d is in seconds

Except for the TLC7701, which can be customized with two external resistors, each supervisor has a fixed SENSE threshold voltage set by an internal voltage divider. When SENSE voltage drops below the threshold voltage, the outputs become active and stay in that state until SENSE voltage returns above threshold voltage and the delay time, t_d , has expired.

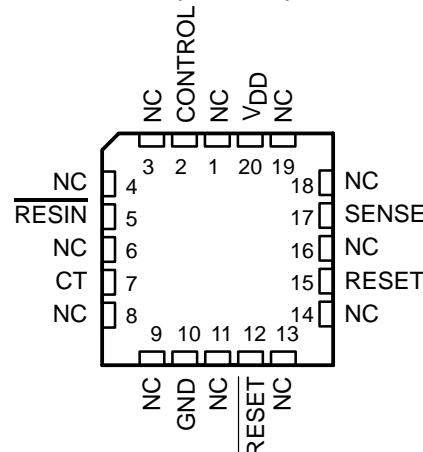
In addition to the power-on-reset and undervoltage-supervisor function, the TLC77xx adds power-down control support for static RAM. When CONTROL is tied to GND, RESET will act as active high. The voltage monitor contains additional logic intended for control of static memories with battery backup during power failure. By driving the chip select (\overline{CS}) of the memory circuit with the RESET output of the TLC77xx and with the CONTROL driven by the memory bank select signal ($\overline{CSH1}$) of the microprocessor (see Figure 10), the memory circuit is automatically disabled during a power loss. (In this application the TLC77xx power has to be supplied by the battery.)

The TLC77xxQ is characterized for operation over a temperature range of -40°C to 125°C , and the TLC77xxL is characterized for operation over a temperature range of -40°C to 85°C .

D, JG, P OR PW PACKAGE
(TOP VIEW)



FK PACKAGE
(TOP VIEW)



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AVAILABLE OPTIONS

TA	THRESHOLD VOLTAGE (V)	PACKAGED DEVICES					CHIP FORM (Y)
		SMALL OUTLINE (D) [†]	CHIP CARRIER (FK)	CERAMIC DIP (JG)	PLASTIC DIP (P)	THIN SHRINK SMALL OUTLINE (PW) [‡]	
–40°C to 85°C	1.1	TLC7701ID	—	—	TLC7701IP	TLC7701IPW	TLC7701Y TLC7725Y TLC7703Y TLC7733Y TLC7705Y
	2.25	TLC7725ID	—	—	TLC7725IP	TLC7725IPW	
	2.63	TLC7703ID	—	—	TLC7703IP	TLC7703IPW	
	2.93	TLC7733ID	—	—	TLC7733IP	TLC7733IPW	
	4.55	TLC7705ID	—	—	TLC7705IP	TLC7705IPW	
–40°C to 125°C	1.1	TLC7701QD	—	—	TLC7701QP	TLC7701QPW	TLC7701Y TLC7725Y TLC7703Y TLC7733Y TLC7705Y
	2.25	TLC7725QD	—	—	TLC7725QP	TLC7725QPW	
	2.63	TLC7703QD	—	—	TLC7703QP	TLC7703QPW	
	2.93	TLC7733QD	—	—	TLC7733QP	TLC7733QPW	
	4.55	TLC7705QD	—	—	TLC7705QP	TLC7705QPW	
–55°C to 125°C	2.93	—	TLC7733MFK	TLC7733MJG	—	—	TLC7701Y TLC7725Y TLC7703Y TLC7733Y TLC7705Y
	4.55	—	TLC7705MFK	TLC7705MJG	—	—	

[†]The D package is available taped and reeled. Add the suffix R to the device type when ordering (e.g., TLC7705QDR).

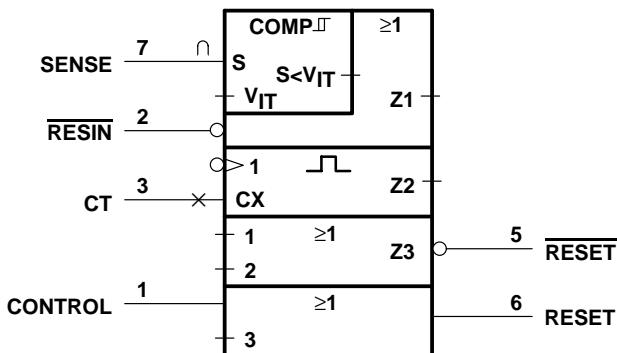
[‡]The PW package is only available left-end taped and reeled (indicated by the LE suffix on the device type; e.g., TLC7705QPWLE).

FUNCTION TABLE

CONTROL	RESIN	$V_I(\text{SENSE}) > V_{IT+}$	RESET	$\overline{\text{RESET}}$
L	L	False	H	L
L	L	True	H	L
L	H	False	H	L
L	H	True	L [§]	H [§]
H	L	False	H	L
H	L	True	H	L
H	H	False	H	L
H	H	True	H	H [§]

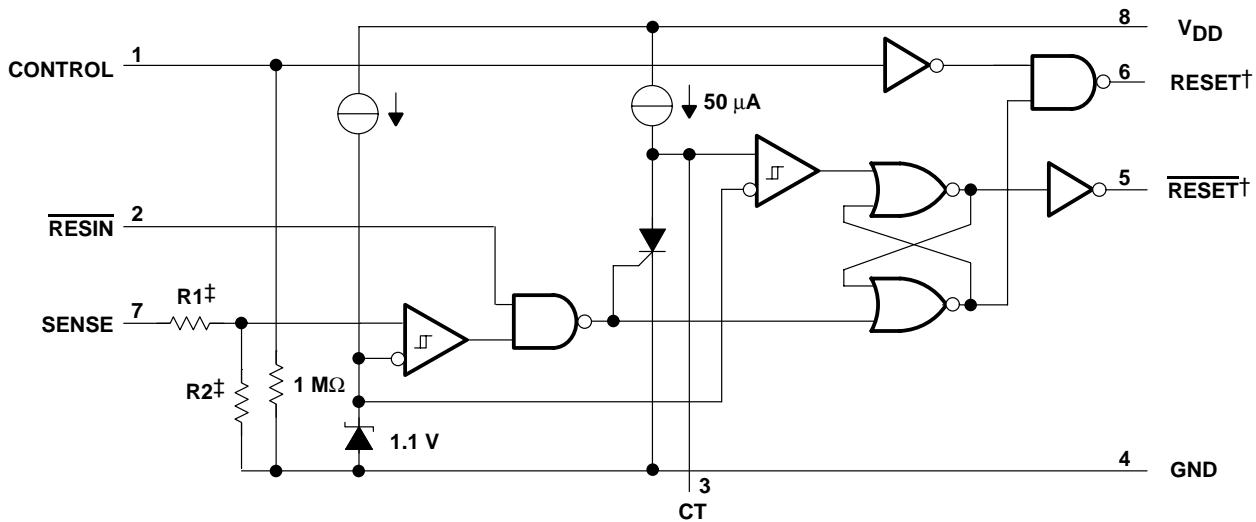
[§]RESET and $\overline{\text{RESET}}$ states shown are valid for $t > t_d$.

logic symbol[¶]



[¶]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

functional block diagram

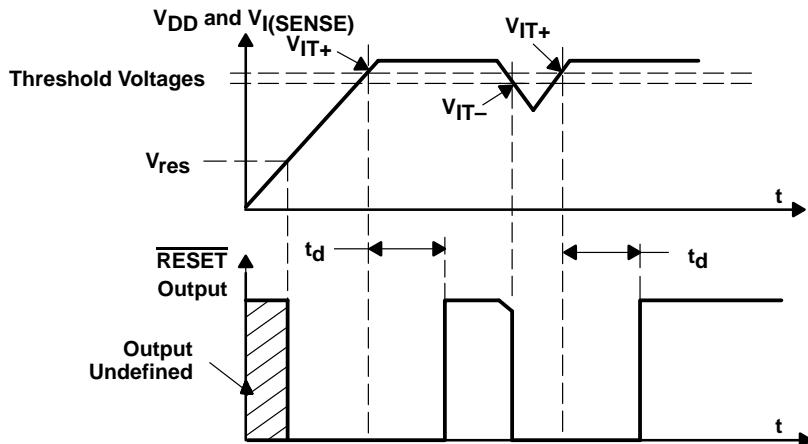


† Outputs are totem-pole configuration. External pullup or pulldown resistors are not required.

‡ Nominal values:

	R1 (Typ)	R2 (Typ)
TLC7701	0	∞
TLC7725	600 k Ω	600 k Ω
TLC7703	698 k Ω	502 k Ω
TLC7733	750 k Ω	450 k Ω
TLC7705	910 k Ω	290 k Ω

timing diagram

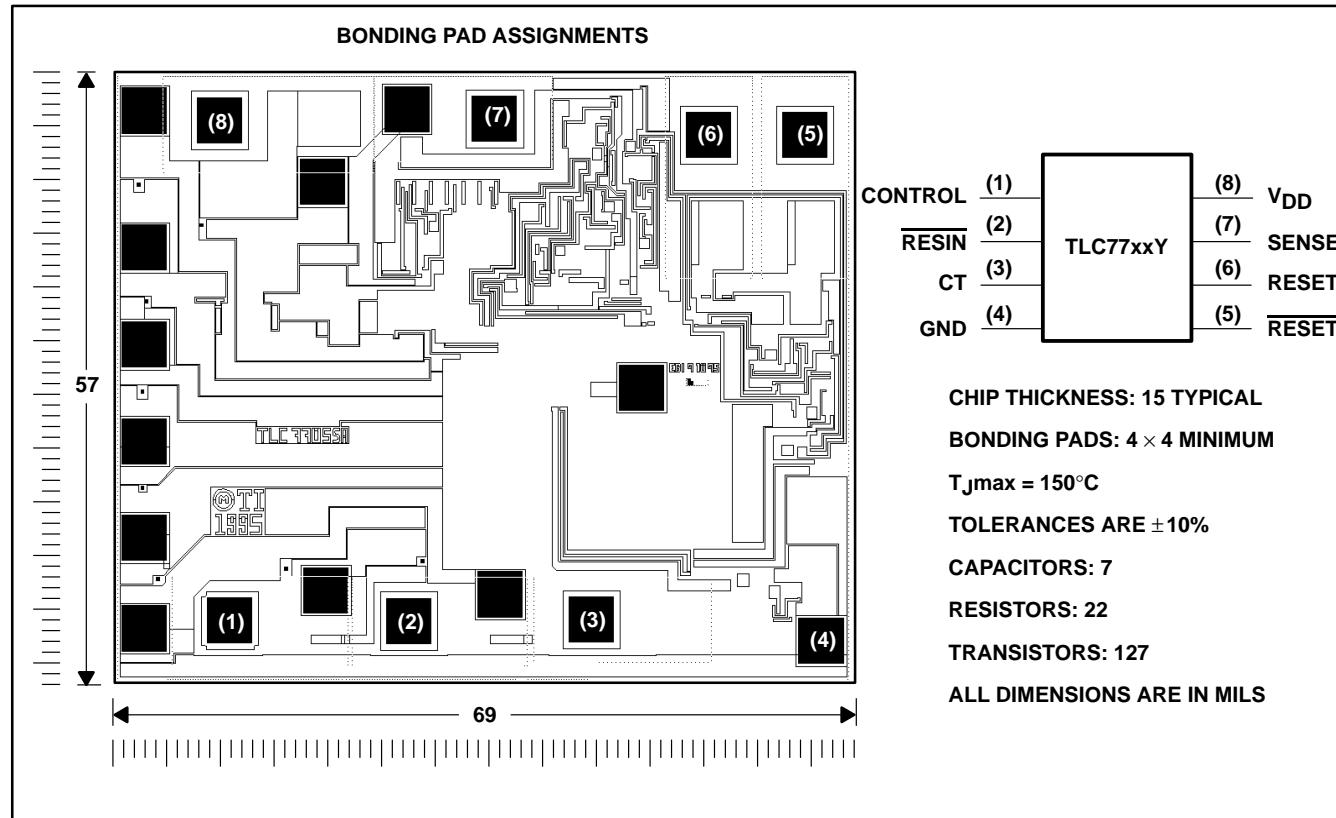


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TLC77xxY chip information

This chip, when properly assembled, displays characteristics similar to those of the TLC77xx. Thermal compression or ultrasonic bonding may be used on the doped aluminum bonding pads. The chips may be mounted with conductive epoxy or a gold-silicon preform.



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absolute maximum ratings over operating free-air temperature (unless otherwise noted)[†]

Supply voltage, V_{DD} (see Note 1)	7 V
Input voltage range, CONTROL, RESIN, SENSE (see Note 1)	-0.3 V to 7 V
Maximum low output current, I_{OL}	10 mA
Maximum high output current, I_{OH}	-10 mA
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{DD}$)	± 10 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{DD}$)	± 10 mA
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A : TL77xxL	-40°C to 85°C
TL77xxQ	-40°C to 125°C
TL77xxM	-55°C to 125°C
Storage temperature range, T_{stg}	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 85^\circ\text{C}$ POWER RATING	$T_A = 125^\circ\text{C}$ POWER RATING
D	725 mW	5.8 mW/°C	377 mW	145 mW
FK	1375 mW	11.0 mW/°C	715 mW	275 mW
JG	1050 mW	8.4 mW/°C	546 mW	210 mW
P	1000 mW	8.0 mW/°C	520 mW	200 mW
PW	525 mW	4.2 mW/°C	273 mW	105 mW

recommended operating conditions at specified temperature range

		MIN	MAX	UNIT
Supply voltage, V_{DD}		2	6	V
Input voltage, V_I		0	V_{DD}	V
High-level input voltage at RESIN and CONTROL [‡] , V_{IH}		0.7× V_{DD}		V
Low-level input voltage at RESIN and CONTROL [‡] , V_{IL}		0.2× V_{DD}		V
High-level output current, I_{OH}	$V_{DD} \geq 2.7$ V	-2		mA
Low-level output current, I_{OL}		2		mA
Input transition rise and fall rate at RESIN and CONTROL, $\Delta t/\Delta V$		100		ns/V
Operating free-air temperature range, T_A	TLC77xxL	-40	85	°C
	TLC77xxQ	-40	125	
Operating free-air temperature range, T_A	TLC77xxM	-55	125	°C

[‡] To ensure a low supply current, V_{IL} should be kept < 0.3 V and $V_{IH} > V_{DD} - 0.3$ V.



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electrical characteristics over recommended operating conditions (see Note 2) (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TLC77xx			UNIT
		MIN	TYP†	MAX	
VOH High-level output voltage	IOH = -20 µA	VDD = 2 V	1.8		V
		VDD = 2.7 V	2.5		
		VDD = 4.5 V	4.3		
	IOH = -2 mA	VDD = 4.5 V	3.7		
VOL Low-level output voltage	IOL = 20 µA	VDD = 2 V	0.2		V
		VDD = 2.7 V	0.2		
		VDD = 4.5 V	0.2		
	IOL = 2 mA	VDD = 4.5 V	0.5		
VIT- Negative-going input threshold voltage, SENSE (see Note 3) Negative-going input threshold voltage, SENSE (see Note 3)	TLC7701		1.04	1.1	1.16
	TLC7725		2.18	2.25	2.32
	TLC7703	VDD = 2 V to 6 V	2.56	2.63	2.70
	TLC7733		2.86	2.93	3
	TLC7705		4.47	4.55	4.63
Vhys Hysteresis voltage, SENSE	TLC7701	VDD = 2 V to 6 V	30		mV
	TLC7725			70	mV
	TLC7703,	VDD = 2 V to 6 V			
	TLC7733,				
	TLC7705				
Vres Power-up reset voltage†	IOL = 20 µA		1		V
I _I Input current	RESIN	V _I = 0 V to VDD	2		µA
	CONTROL	V _I = VDD	7	15	
	SENSE	V _I = 5 V	5	10	
	SENSE, TLC7701 only	V _I = 5 V	2		
IDD Supply current	RESIN = VDD, SENSE = VDD ≥ V _{ITmax} + 0.2 V CONTROL = 0 V, Outputs open			9	16
IDD(d) Supply current during t _d	VDD = 5 V, V _{CT} = 0, RESIN = VDD, SENSE = VDD, CONTROL = 0 V, Outputs open			120	150
C _I Input capacitance, SENSE	V _I = 0 V to VDD		50		pF

† Typical values apply at T_A = 25°C.

‡ The lowest supply voltage at which RESET becomes active. The symbol V_{res} is not currently listed within EIA or JEDEC standards for semiconductor symbology. Rise time of VDD ≥ 15 µs/V.

NOTES: 2. All characteristics are measured with C_T = 0.1 µF.

3. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1 µF) should be connected near the supply terminals.



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electrical characteristics over recommended operating conditions (see Note 2) (unless otherwise noted)

PARAMETER		TEST CONDITIONS		TLC77xxM			UNIT	
				MIN	TYP†	MAX		
V_{OH}	High-level output voltage	$I_{OH} = -20 \mu A$	$V_{DD} = 2 V$	$T_A = 25^\circ C$	1.8		V	
				$T_A = -55^\circ C$ to $125^\circ C$	1.7			
			$V_{DD} = 2.7 V$	$T_A = 25^\circ C$	2.5			
				$T_A = -55^\circ C$ to $125^\circ C$	2.3			
			$V_{DD} = 4.5 V$	$T_A = 25^\circ C$	4.3			
				$T_A = -55^\circ C$ to $125^\circ C$	4.2			
				$T_A = 25^\circ C$	3.7			
	Low-level output voltage	$I_{OL} = 20 \mu A$	$V_{DD} = 4.5 V$	$T_A = -55^\circ C$ to $125^\circ C$	3.6		V	
				$T_A = 25^\circ C$	0.2			
			$V_{DD} = 2.7 V$	$T_A = -55^\circ C$ to $125^\circ C$	0.2			
				$T_A = 25^\circ C$	0.2			
			$V_{DD} = 4.5 V$	$T_A = -55^\circ C$ to $125^\circ C$	0.2			
				$T_A = 25^\circ C$	0.2			
				$T_A = -55^\circ C$ to $125^\circ C$	0.5			
V_{IT-}	Negative-going input threshold voltage, SENSE (see Note 3)	TLC7733	$V_{DD} = 2 V$ to $6 V$		2.86	2.93	3	V
		TLC7705			4.3	4.5	4.8	
V_{hys}	Hysteresis voltage, SENSE		$V_{DD} = 2 V$ to $6 V$	$V_{DD} = 2 V$ to $6 V$	70		mV	
V_{res}	Power-up reset voltage‡		$I_{OL} = 20 \mu A$			1	V	
I_I	Input current	RESIN	$V_I = 0 V$ to V_{DD}			2	μA	
		CONTROL	$V_I = V_{DD}$			7		
		SENSE	$V_I = 5 V$			5		
		SENSE, TLC7701 only	$V_I = 5 V$			2		
I_{DD}	Supply current		$RESIN = V_{DD}$, $SENSE = V_{DD} \geq V_{IT\max} + 0.2 V$, $CONTROL = 0 V$, Outputs open			9	16	
$I_{DD(d)}$	Supply current during t_d	TLC7733	$V_{CT} = 0$, $RESIN = V_{DD}$, $CONTROL = 0 V$, $SENSE = V_{DD}$, Outputs open	$V_{DD} = 3.3 V$	120	150	μA	
		TLC7705		$V_{DD} = 5 V$		250		
C_I	Input capacitance, SENSE		$V_I = 0 V$ to V_{DD}			50	pF	

† Typical values apply at $T_A = 25^\circ C$.

‡ The lowest supply voltage at which RESET becomes active. The symbol V_{res} is not currently listed within EIA or JEDEC standards for semiconductor symbology. Rise time of $V_{DD} \geq 15 \mu s/V$.

NOTES: 2. All characteristics are measured with $C_T = 0.1 \mu F$.

3. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, $0.1 \mu F$) should be placed near the supply terminals.

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electrical characteristics over recommended operating conditions, $T_A = 25^\circ\text{C}$, $C_T = 0.1 \mu\text{F}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TLC77xxY			UNIT		
		MIN	TYP	MAX			
V_{IT-} Negative-going input threshold voltage, SENSE (see Note 3)	TLC7701	$V_{DD} = 2 \text{ V to } 6 \text{ V}$	1.1		V		
	TLC7725		2.25				
	TLC7703		2.63				
	TLC7733		2.93				
	TLC7705		4.55				
V_{hys} Hysteresis voltage, SENSE	TLC7701	$V_{DD} = 2 \text{ V to } 6 \text{ V}$	30	mV			
	TLC7725	$V_{DD} = 2 \text{ V to } 6 \text{ V}$	70				
	TLC7703,						
	TLC7733,						
	TLC7705						
I_I Input current	CONTROL	$V_I = V_{DD}$	7	μA			
	RESIN	$V_I = 0 \text{ V to } V_{DD}$					
	SENSE	$V_I = 5 \text{ V}$	5				
	SENSE, TLC7701 only		1				
I_{DD} Supply current	$\text{RESIN} = V_{DD},$ $\text{SENSE} = V_{DD} > V_{IT+max} + 0.2 \text{ V},$ $\text{CONTROL} = 0 \text{ V}, \text{ Outputs open}$		9	μA			
	$\text{RESIN} = V_{DD},$ $\text{SENSE} = V_{DD},$ $\text{CONTROL} = 0 \text{ V}, \text{ Outputs open}$		9				
$I_{DD(d)}$ Supply current during delay time	$V_{DD} = 5 \text{ V},$ $V_{CT} = 0,$ $\text{RESIN} = V_{DD},$ $\text{SENSE} = V_{DD},$ $\text{CONTROL} = 0 \text{ V}, \text{ Outputs open}$		120	μA			
C_I Input capacitance, SENSE	$V_I = 0 \text{ V to } V_{DD}$		50				

NOTE 3: To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, $0.1 \mu\text{F}$) should be connected near the supply terminals.



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switching characteristics at $V_{DD} = 5 \text{ V}$, $R_L = 2 \text{ k}\Omega$, $C_L = 50 \text{ pF}$, $T_A = 25^\circ\text{C}$

PARAMETER	MEASURED		TEST CONDITIONS	TLC77xx			UNIT
	FROM (INPUT)	TO (OUTPUT)		MIN	TYP	MAX	
t_d Delay time	$V_I(\text{SENSE}) \geq V_{IT+}$	RESET and <u>RESET</u>	$\overline{\text{RESIN}} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $C_T = 100 \text{ nF}$, See timing diagram	1.1	2.1	4.2	ms
t_{PLH} Propagation delay time, low-to-high-level output	SENSE	<u>RESET</u>	$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$, $\overline{\text{RESIN}} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	20	μs		
t_{PHL} Propagation delay time, high-to-low-level output				5			
t_{PLH} Propagation delay time, low-to-high-level output		RESET		5			
t_{PHL} Propagation delay time, high-to-low-level output				20			
t_{PLH} Propagation delay time, low-to-high-level output	RESIN	<u>RESET</u>	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	20	μs		
t_{PHL} Propagation delay time, high-to-low-level output				40	ns		
t_{PLH} Propagation delay time, low-to-high-level output		RESET		45			
t_{PHL} Propagation delay time, high-to-low-level output				20	μs		
t_{PLH} Propagation delay time, low-to-high-level output	CONTROL	RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\overline{\text{RESIN}} = 0.7 \times V_{DD}$, $CT = NC^\dagger$	38	ns		
t_{PHL} Propagation delay time, high-to-low-level output				38	ns		
Low-level minimum pulse duration to switch RESET and <u>RESET</u>	SENSE		$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$	3	μs		
			$V_{IL} = 0.2 \times V_{DD}$, $V_{IH} = 0.7 \times V_{DD}$	1			
t_r Rise time		RESET and <u>RESET</u>	10% to 90%	8	ns/V		
t_f Fall time			90% to 10%	4			

[†]NC = No capacitor, and includes up to 100-pF probe and jig capacitance.

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switching characteristics at $V_{DD} = 5 \text{ V}$, $R_L = 2 \text{ k}\Omega$, $C_L = 50 \text{ pF}$

PARAMETER	MEASURED		TEST CONDITIONS	T_A	TLC77xxM			UNIT	
	FROM (INPUT)	TO (OUTPUT)			MIN	TYP	MAX		
t_d	Delay time	$V_I(\text{SENSE}) \geq V_{IT+}$	RESET and RESET	$\text{RESIN} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $C_T = 100 \text{ nF}$, See timing diagram	25°C	1.1	2.1	4.2	ms
t_{PLH}	Propagation delay time, low-to-high-level output	SENSE	RESET	$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$, $\text{RESIN} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	20	24	μs	
			RESET	$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$, $\text{RESIN} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	5	7		
		SENSE	RESET	$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$, $\text{RESIN} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	20	24	μs	
			RESET	$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$, $\text{RESIN} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	5	7		
t_{PLH}	Propagation delay time, high-to-low-level output	SENSE	RESET	$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$, $\text{RESIN} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	20	24	μs	
			RESET	$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$, $\text{RESIN} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	20	24		
		RESIN	RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	45	65	ns	
			RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	40	60		
t_{PHL}	Propagation delay time, low-to-high-level output	RESIN	RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	20	24	μs	
			RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	20	24		
		RESIN	RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	40	60	ns	
			RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	25°C	20	24		
t_{PLH}	Propagation delay time, high-to-low-level output	CONTROL	RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{RESIN} = 0.7 \times V_{DD}$, $CT = NC^\dagger$	25°C	38	58	ns	
			RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{RESIN} = 0.7 \times V_{DD}$, $CT = NC^\dagger$	25°C	38	58		
t_{PHL}	Propagation delay time, low-to-high-level output		SENSE	$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$	Full range	3	1	μs	
			RESIN	$V_{IL} = 0.2 \times V_{DD}$, $V_{IH} = 0.7 \times V_{DD}$	Full range	1	1		
t_r	Rise time		RESET and RESET	10% to 90%	Full range	8	8	ns/V	
t_f	Fall time		RESET and RESET	90% to 10%	Full range	4	4		

^d NC = No capacitor, and includes up to 100-pF probe and jig capacitance.

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switching characteristics at $V_{DD} = 5 \text{ V}$, $R_L = 2 \text{ k}\Omega$, $C_L = 50 \text{ pF}$, $T_A = 25^\circ\text{C}$

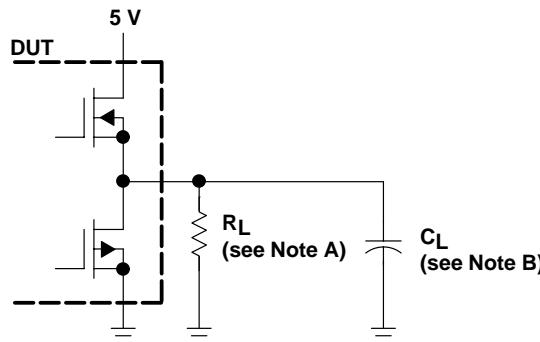
PARAMETER	MEASURED		TEST CONDITIONS	TLC77xxY			UNIT	
	FROM (INPUT)	TO (OUTPUT)		MIN	TYP	MAX		
t_d Delay time	$V_I(\text{SENSE}) \geq V_{IT+}$	RESET and RESET	$\overline{\text{RESIN}} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $C_T = 100 \text{ nF}$, See timing diagram		2.1		ms	
t_{PLH} Propagation delay time, low-to-high-level output	SENSE	RESET	$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$, $\overline{\text{RESIN}} = 0.7 \times V_{DD}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	20			μs	
t_{PHL} Propagation delay time, high-to-low-level output				5				
t_{PLH} Propagation delay time, low-to-high-level output		RESET		5				
t_{PHL} Propagation delay time, high-to-low-level output				20				
t_{PLH} Propagation delay time, low-to-high-level output	RESIN	RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\text{CONTROL} = 0.2 \times V_{DD}$, $CT = NC^\dagger$	20			μs	
t_{PHL} Propagation delay time, high-to-low-level output				40			ns	
t_{PLH} Propagation delay time, low-to-high-level output		RESET		45				
t_{PHL} Propagation delay time, high-to-low-level output				20			μs	
t_{PLH} Propagation delay time, low-to-high-level output	CONTROL	RESET	$V_{IH} = 0.7 \times V_{DD}$, $V_{IL} = 0.2 \times V_{DD}$, $\text{SENSE} = V_{IT+}\text{max} + 0.2 \text{ V}$, $\overline{\text{RESIN}} = 0.7 \times V_{DD}$, $CT = NC^\dagger$	38			ns	
t_{PHL} Propagation delay time, high-to-low-level output				38			ns	
Low-level minimum pulse duration to switch RESET and RESET	SENSE		$V_{IH} = V_{IT+}\text{max} + 0.2 \text{ V}$, $V_{IL} = V_{IT-}\text{min} - 0.2 \text{ V}$	3			μs	
			$V_{IL} = 0.2 \times V_{DD}$, $V_{IH} = 0.7 \times V_{DD}$	1				
t_r Rise time		RESET and RESET	10% to 90%		8		ns/V	
t_f Fall time			90% to 10%		4			

[†]NC = No capacitor, and includes up to 100-pF probe and jig capacitance.

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. For switching characteristics, $R_L = 2 \text{ k}\Omega$.
B. $C_L = 50 \text{ pF}$ includes jig and probe capacitance.

Figure 1. RESET AND $\overline{\text{RESET}}$ Output Configurations

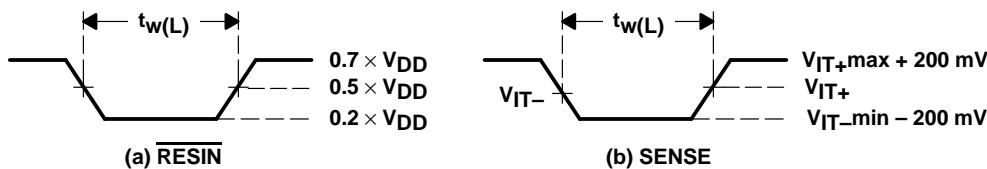


Figure 2. Input Pulse Definition Waveforms

TYPICAL CHARACTERISTICS

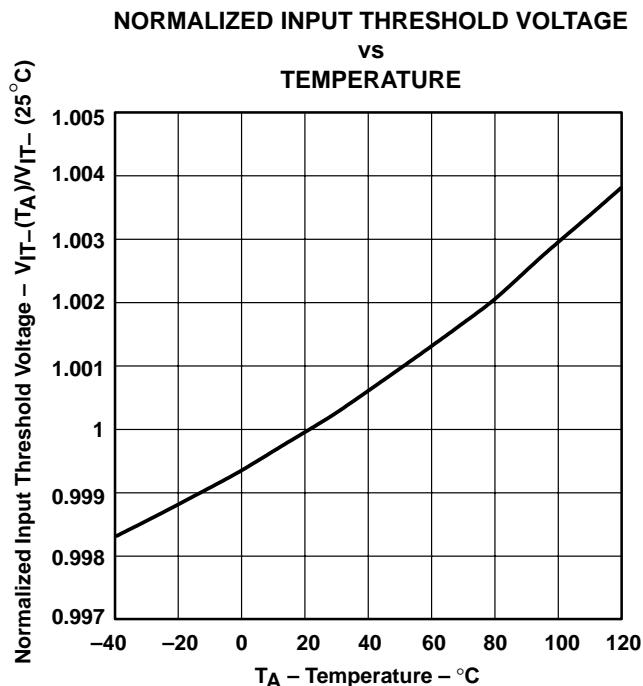


Figure 3

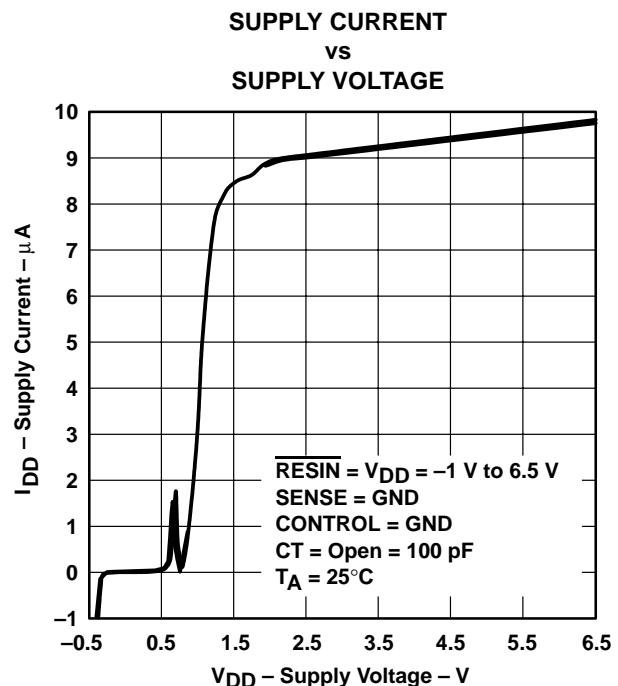


Figure 4

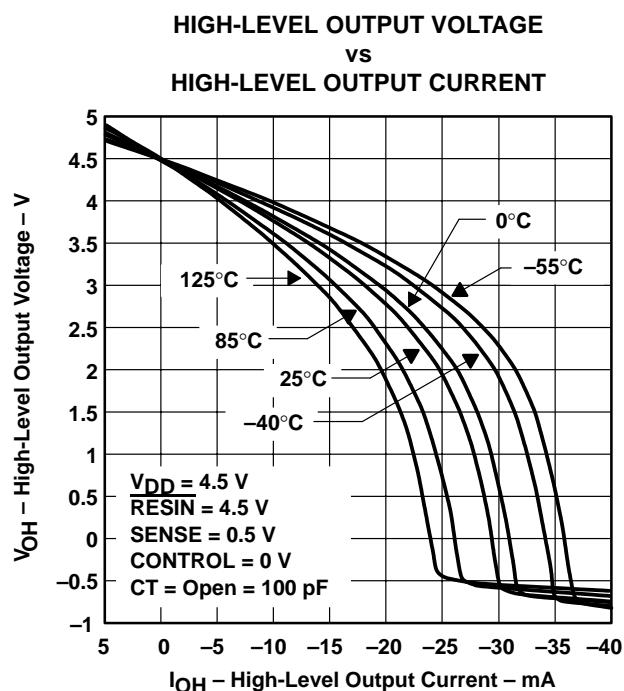


Figure 5

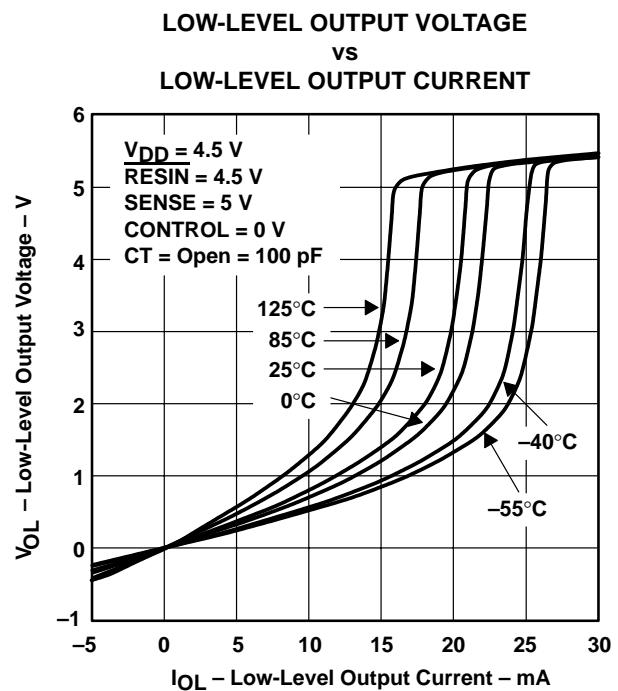


Figure 6

TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

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TYPICAL CHARACTERISTICS

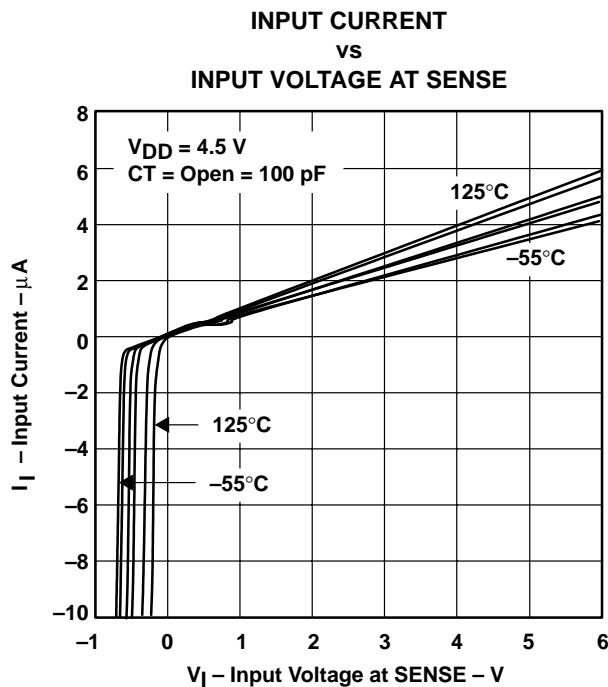


Figure 7

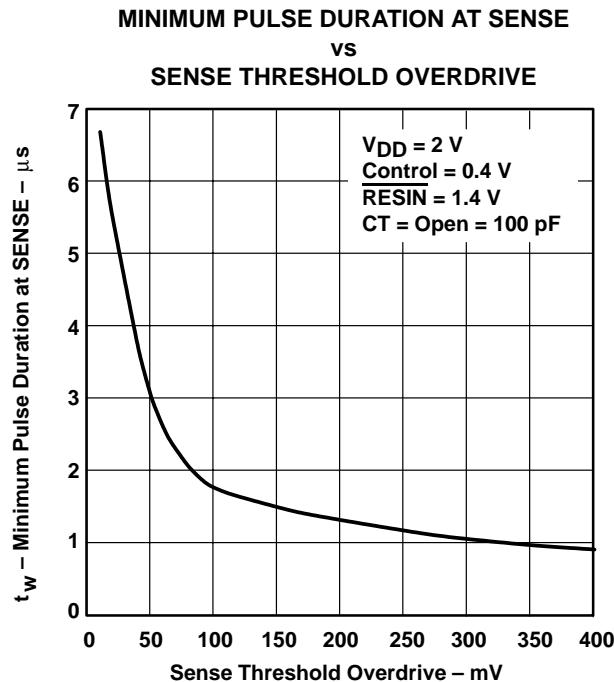


Figure 8

APPLICATION INFORMATION

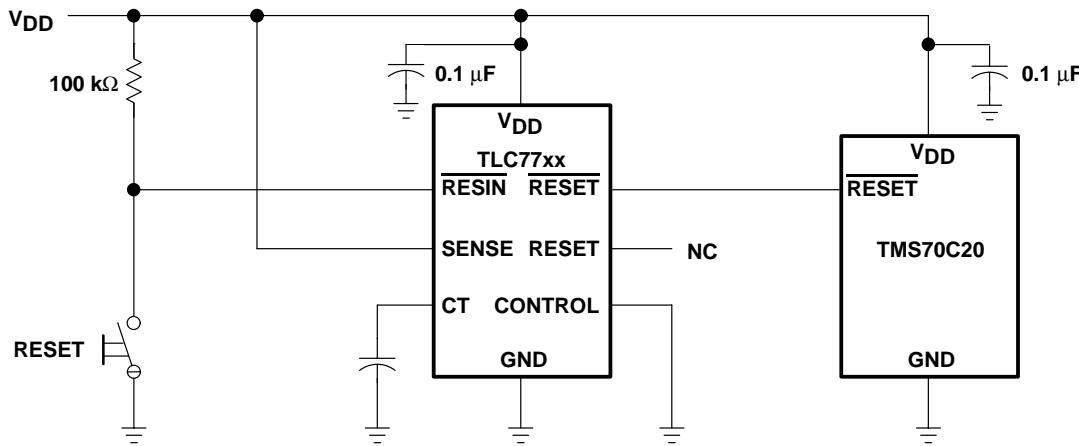


Figure 9. Reset Controller in a Microcomputer System

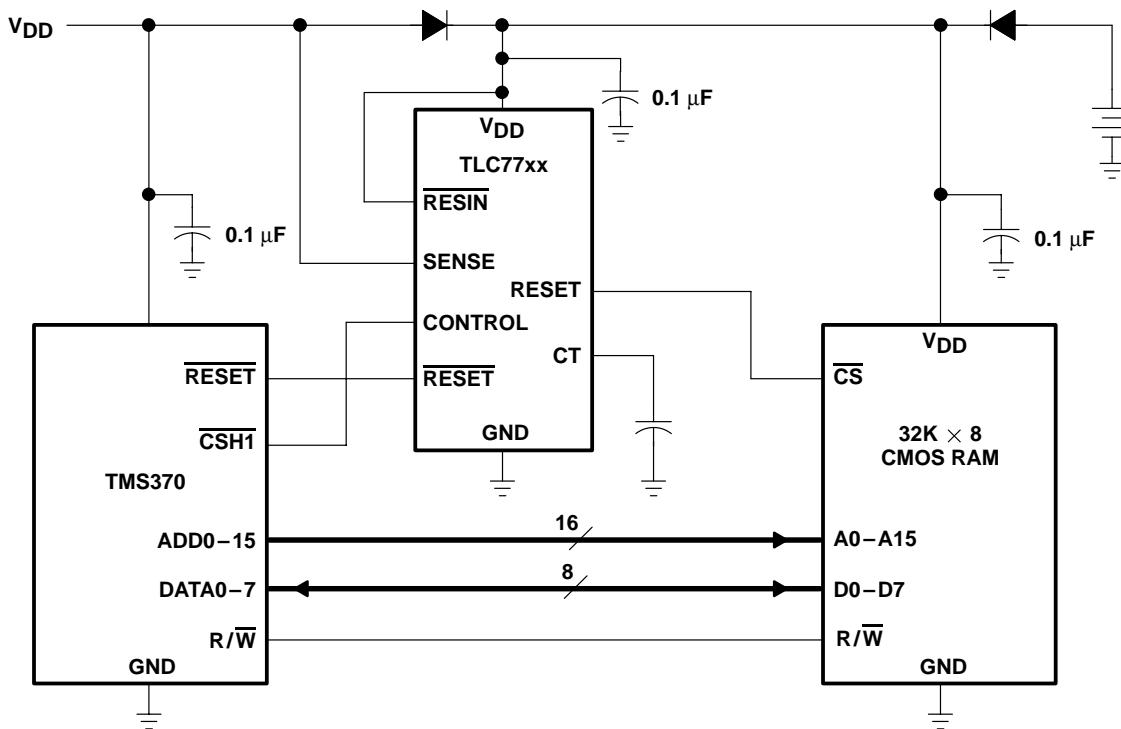


Figure 10. Data Retention During Power Down Using Static CMOS RAMs

TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

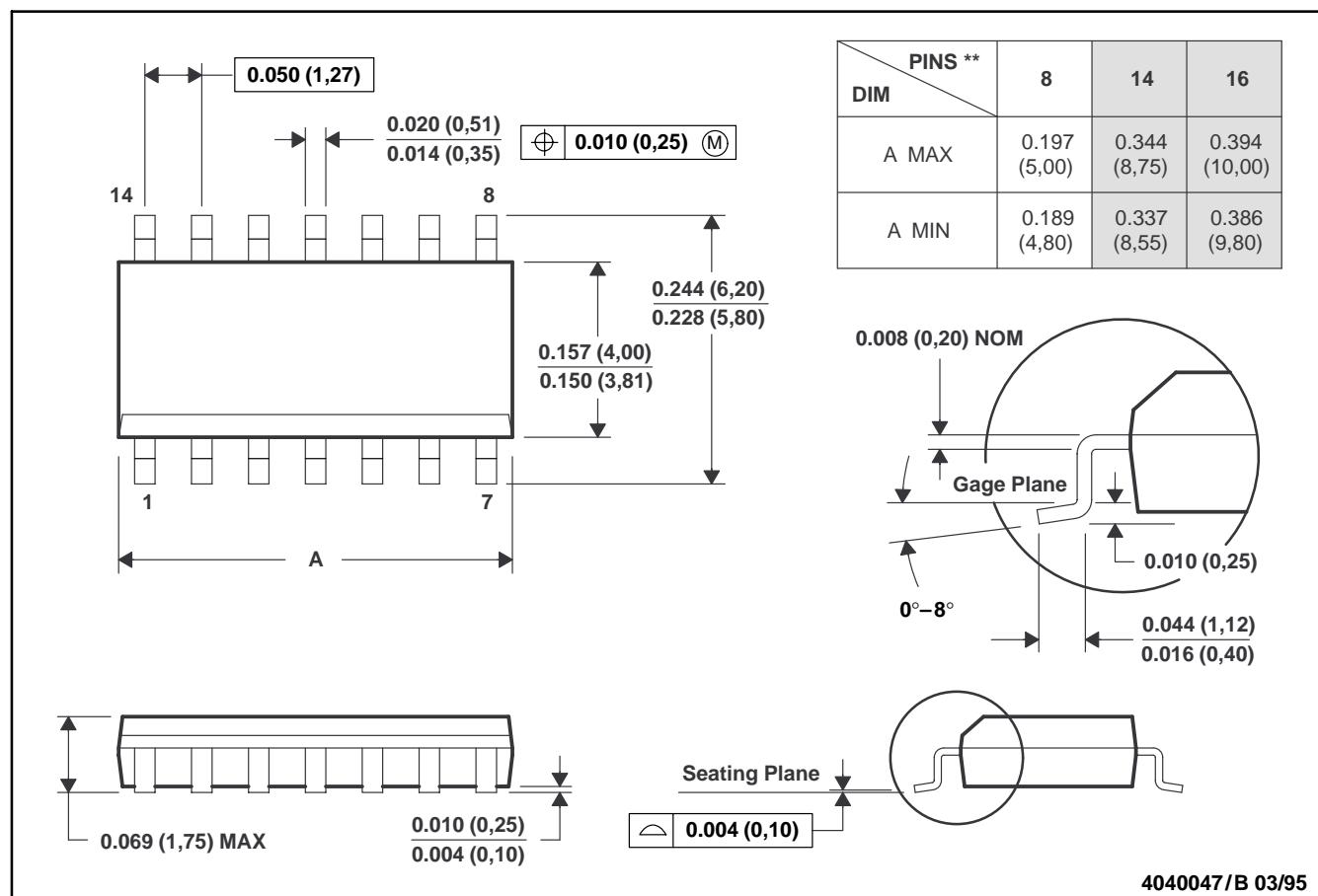
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MECHANICAL DATA

D (R-PDSO-G**)

14 PIN SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



4040047/B 03/95

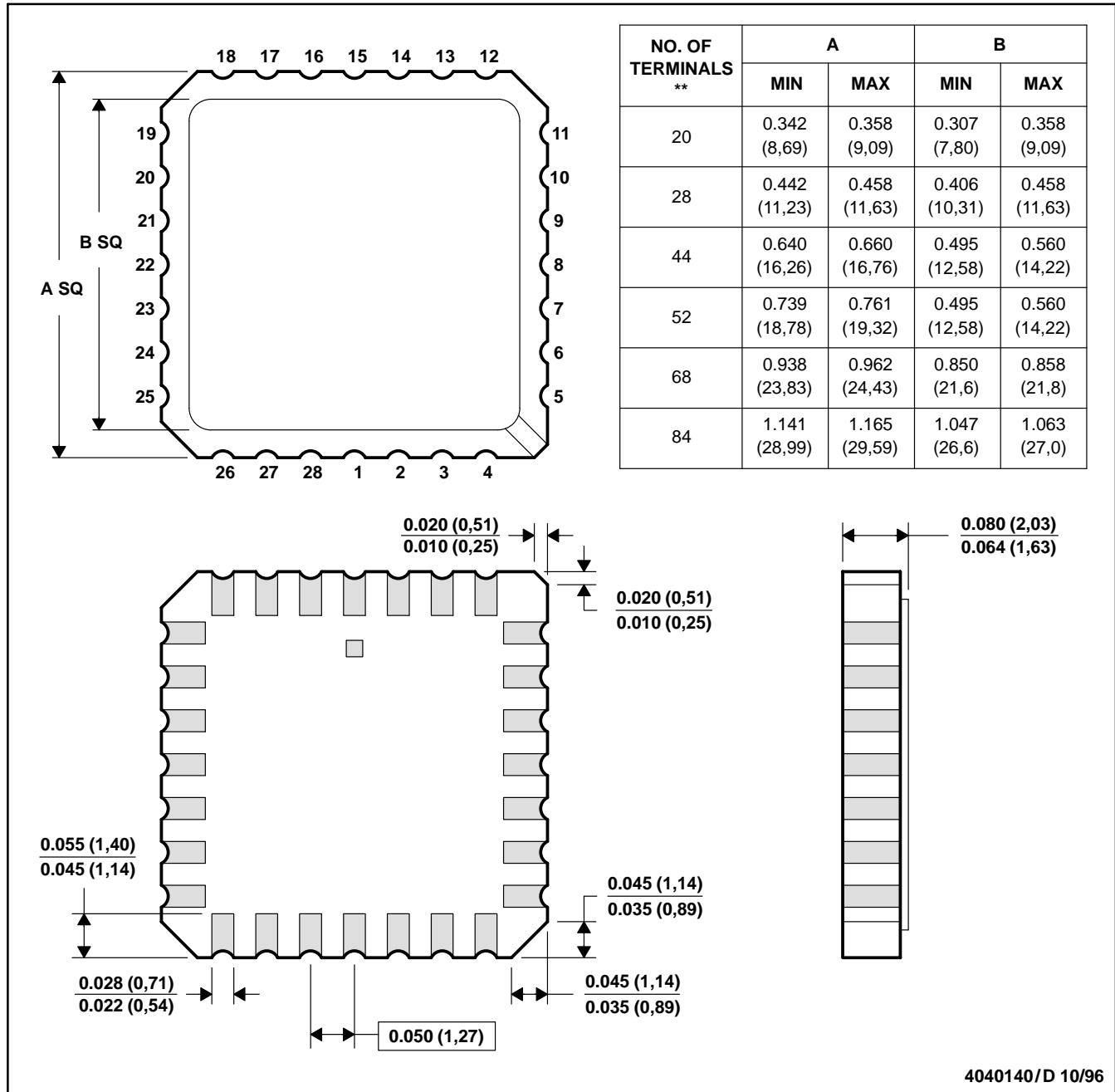
- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
 - Four center pins are connected to die mount pad.
 - Falls within JEDEC MS-012

MECHANICAL DATA

FK (S-CQCC-N)**

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - The terminals are gold plated.
 - Falls within JEDEC MS-004

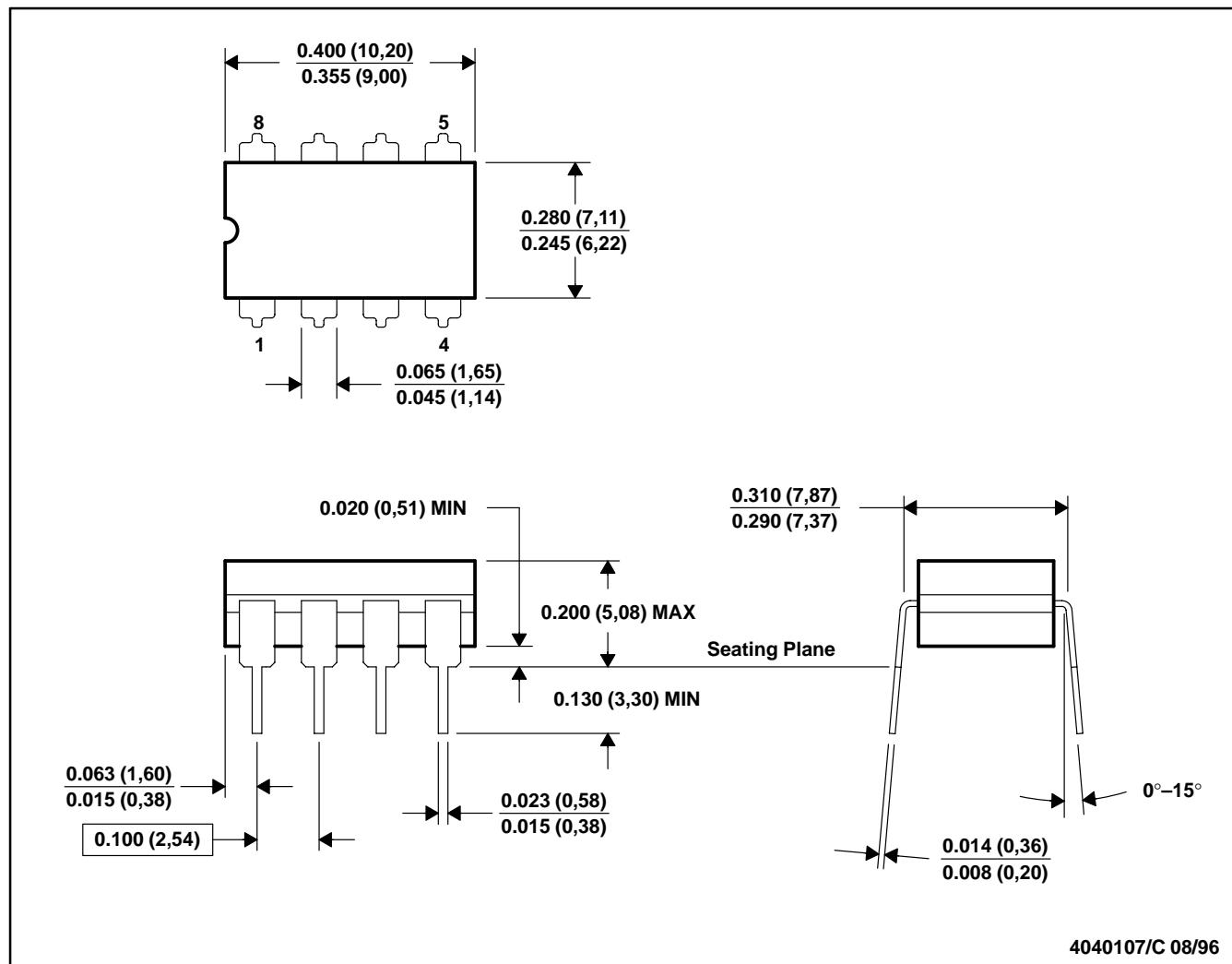
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MECHANICAL DATA

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE PACKAGE



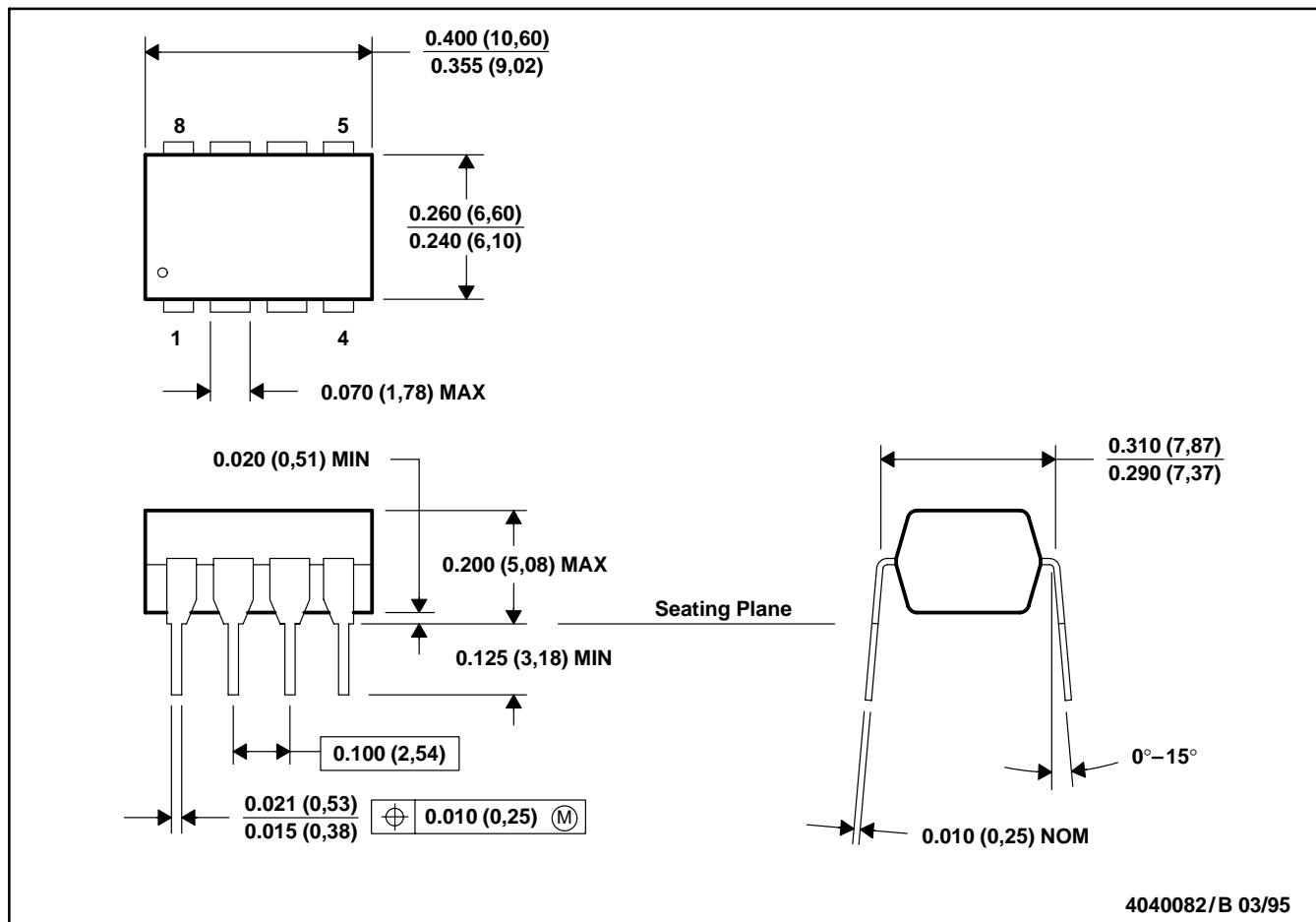
4040107/C 08/96

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL-STD-1835 GDIP1-T8

MECHANICAL DATA

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

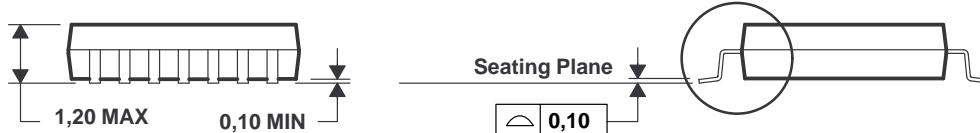
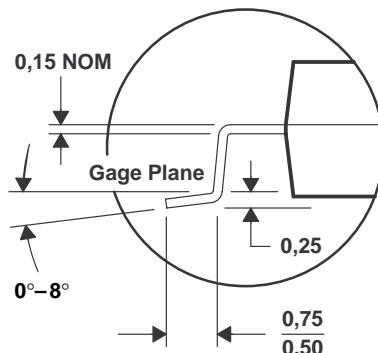
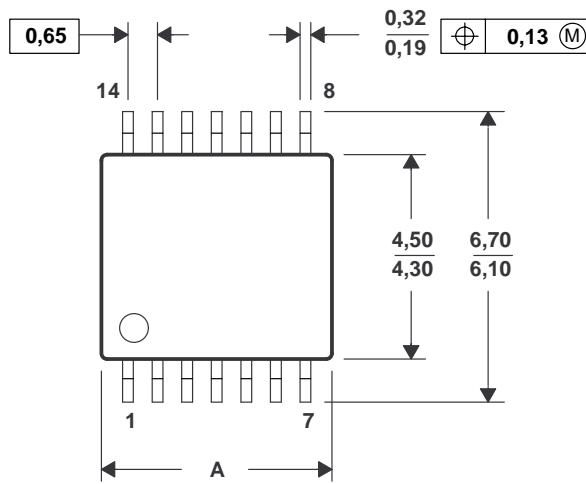
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MECHANICAL DATA

PW (R-PDSO-G**)

14 PIN SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



PINS ** DIM	8	14	16	20	24	28
A MAX	3.10	5.10	5.10	6.60	7.90	9.80
A MIN	2.90	4.90	4.90	6.40	7.70	9.60

4040064/D 10/95

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.15.
 - D. Falls within JEDEC MO-153

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